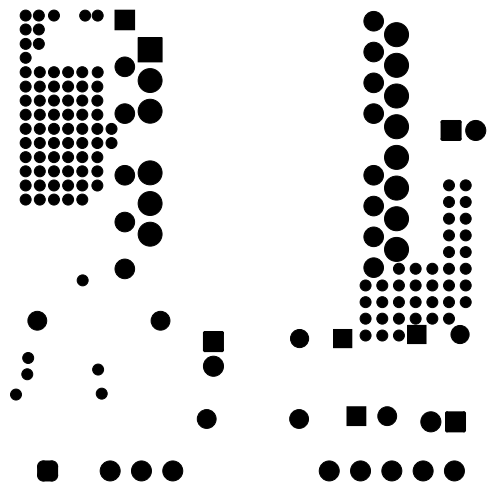
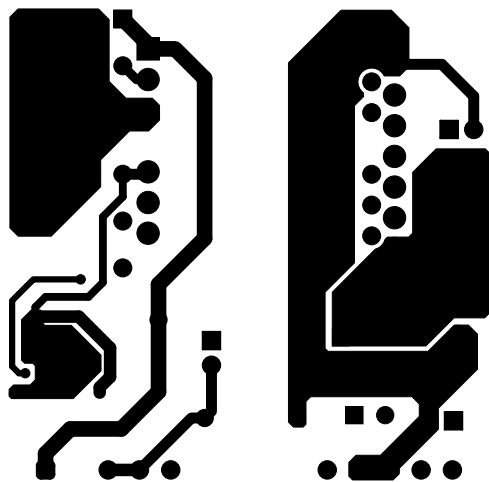


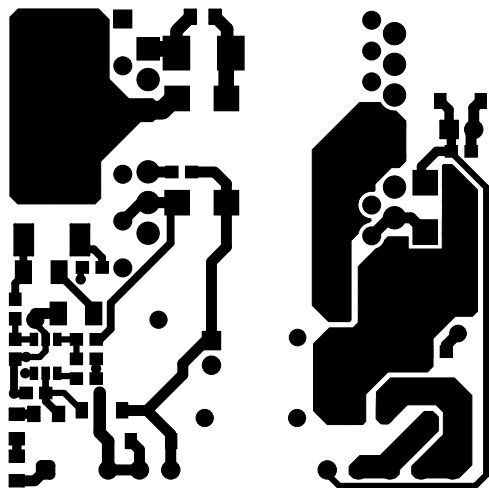
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01503	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01503		
PLOT NAME = TIDA-01503_PCB.GTO	GENERATED : 10/26/2017 12:29:46 PM		TEXAS INSTRUMENTS



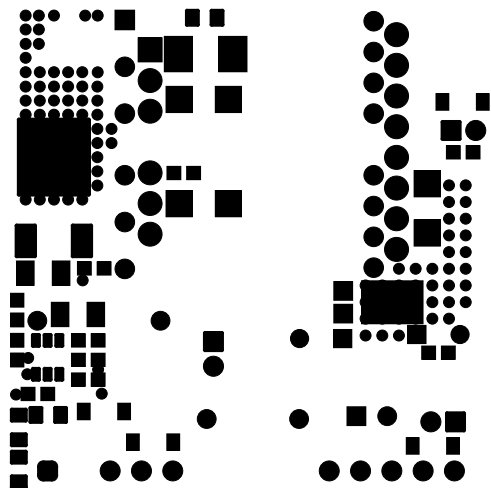
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01503	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01503		
PLOT NAME = TIDA-01503_PCB.GTS	GENERATED : 10/26/2017 12:29:47 PM		TEXAS INSTRUMENTS



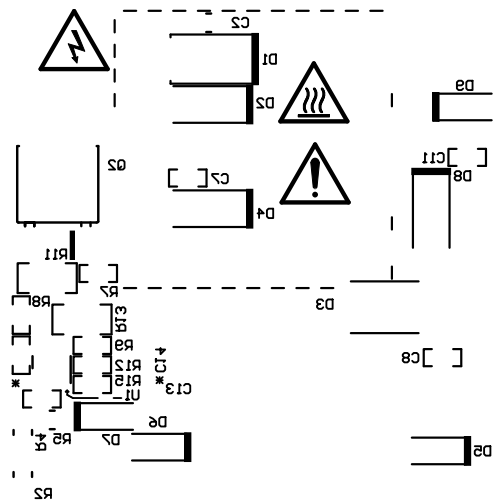
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01503	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01503		
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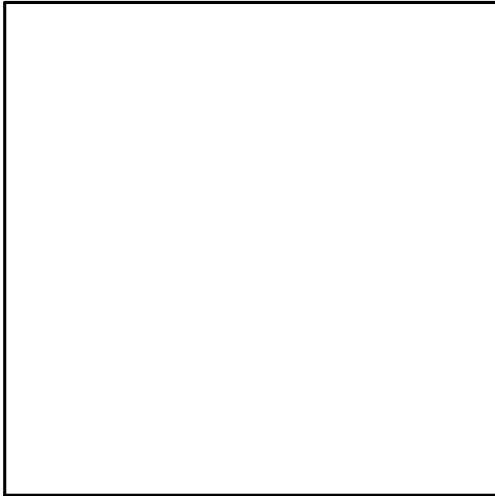
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LAYER NAME = Bottom Layer	TID #: TIDA-01503		
PLOT NAME = TIDA-01503_PCB.GBL	GENERATED : 10/26/2017 12:29:46 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01503	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01503		
PLOT NAME = TIDA-01503_PCB.GBS	GENERATED : 10/26/2017 12:29:47 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01503	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01503		
PLOT NAME = TIDA-01503_PCB.GB0	GENERATED : 10/26/2017 12:29:47 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01503	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline	TID #: TIDA-01503		
PLOT NAME = TIDA-01503_PCB.GM1	GENERATED : 10/26/2017 12:29:47 PM		TEXAS INSTRUMENTS

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